

4-146253-0 ✓ ACTIVE

AMPMODU | [AMPMODU Headers](#)

TE Internal #: 4-146253-0

PCB Mount Header, Vertical, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

[View on TE.com >](#)



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **80**

Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	80
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Operating Voltage	30 VAC
-------------------	--------

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
------------------------------	-----------------



	100 – 200 µin
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 µm[30 µin]
Contact Type	Pin
Contact Current Rating (Max)	3 A

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic

Dimensions

Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]

Usage Conditions

Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

Industry Standards

Approved Standards	CSA LR7189, UL E28476
--------------------	-----------------------

UL Flammability Rating

UL 94V-0

Packaging Features

Packaging Quantity

50

Packaging Type

Carton

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU

Not Compliant

EU ELV Directive 2000/53/EC

Compliant with Exemptions

China RoHS 2 Directive MIIT Order No 32, 2016

Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2022 (224)

Candidate List Declared Against: JUNE 2022 (224)

SVHC > Threshold:

Pb (13% in Component Part)

Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



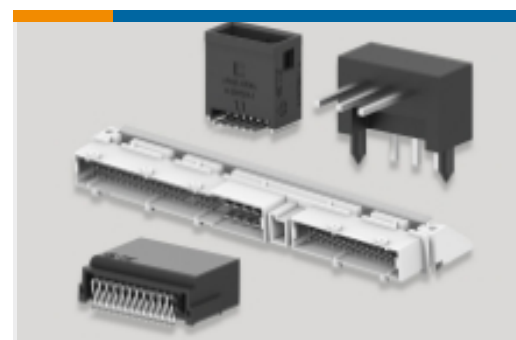
Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



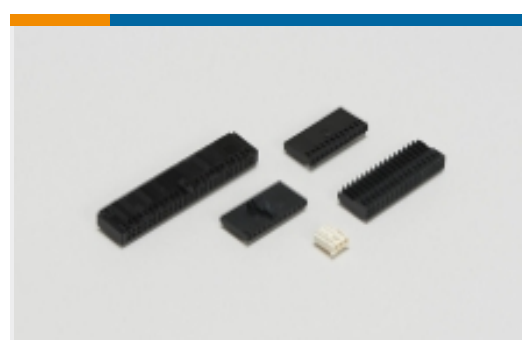
PCB Connector Shrouds(1)



PCB Headers & Receptacles(6830)



PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(66)

Documents

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_4-146253-0_E.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_4-146253-0_E.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_4-146253-0_E.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[AMPMODU Interconnection System](#)

4-146253-0

PCB Mount Header, Vertical, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



AMPMODU Interconnection System

English